# MA2X334 (MA334)

## Silicon epitaxial planar type

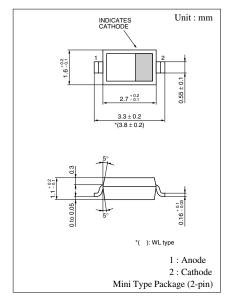
For UHF and VHF electronic tuners

#### ■ Features

- Large capacitance ratio
- Small series resistance rD
- Mini type package, allowing downsizing of equipment and automatic insertion through the taping package

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage (DC)	$V_R$	30	V	
Peak reverse voltage	$V_{RM}$	34	V	
Forward voltage (DC)	$I_F$	20	mA	
Junction temperature	T <sub>j</sub>	150	°C	
Storage temperature	$T_{stg}$	-55 to +150	°C	



Marking Symbol: 6D

### ■ Electrical Characteristics $T_a = 25$ °C

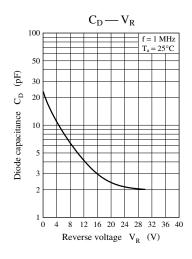
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse current (DC)	I <sub>R</sub>	$V_R = 30 \text{ V}$			10	nA
Diode capacitance	C <sub>D(3V)</sub>	$V_R = 3 \text{ V, } f = 1 \text{ MHz}$	11.233		12.781	pF
	C <sub>D(25V)</sub>	$V_R = 25 \text{ V}, f = 1 \text{ MHz}$	2.020		2.367	pF
	C <sub>D(10V)</sub>	$V_R = 10 \text{ V}, f = 1 \text{ MHz}$	4.358		5.422	pF
	C <sub>D(17V)</sub>	$V_R = 17 \text{ V}, f = 1 \text{ MHz}$	2.567		3.100	pF
Capacitance ratio	C <sub>D(3V)</sub> /C <sub>D(25V)</sub>		4.60		6.15	_
Capacitance difference	C <sub>D(17V)</sub> /C <sub>D(25V)</sub>		0.37			pF
Diode capacitance deviation	ΔC	C <sub>D(3V)(10V)(17V)(25V)</sub>			2	%
Series resistance*	$r_{\mathrm{D}}$	$C_D = 9 \text{ pF, } f = 470 \text{ MHz}$	0.38		0.72	Ω

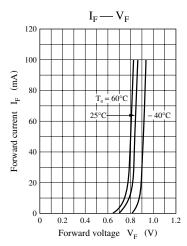
Note) 1. Rated input/output frequency: 470 MHz

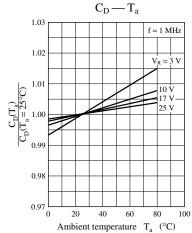
Note) The part number in the parenthesis shows conventional part number.

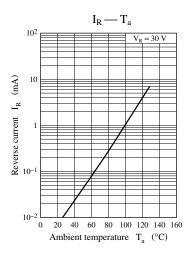
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<sup>2. \*:</sup> r<sub>f</sub> measuring instrument: YHP MODEL 4191A RF IMPEDANCE ANALYZER





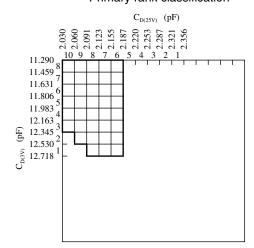




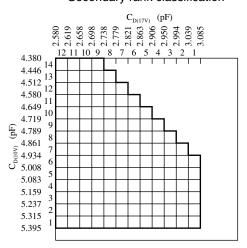
#### C<sub>D</sub> rank classification

#### •MA2X334B

#### Primary rank classification

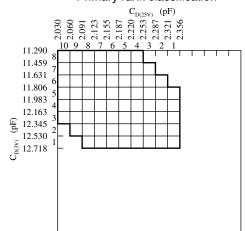


#### Secondary rank classification

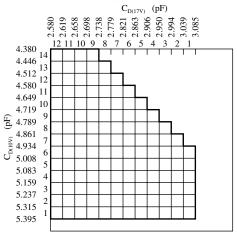


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# •MA2X3340G Primary rank classification



#### Secondary rank classification



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